

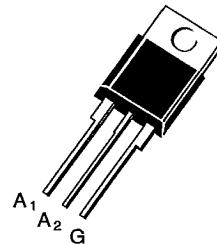
S G S-THOMSON

TRIACS

- GLASS PASSIVATED CHIP
- I_{GT} SPECIFIED IN FOUR QUADRANTS
- INSULATING VOLTAGE : 2500 VRMS
- UL RECOGNIZED (E81734)

ADVANTAGES

- $I_H < 13$ mA
- HIGH SURGE CURRENT : $I_{TSM} = 50$ A

TO 220 AB
(Plastic)**DESCRIPTION**

Insulated triacs specified for light dimmer applications.

ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value	Unit
$I_T(\text{RMS})$	RMS on-state Current (360° conduction angle)	4	A
I_{TSM}	$t = 8.3$ ms	52	A
	$t = 10$ ms	50	
I^2t	I^2t Value for Fusing	12.5	A^2s
dI/dt	Critical Rate of Rise of on-state Current (1)	10	$\text{A}/\mu\text{s}$
	Repetitive $F = 50$ Hz	50	
T_{stg} T_J	Storage and Operating Junction Temperature Range	- 40 to 125 - 40 to 110	$^{\circ}\text{C}$ $^{\circ}\text{C}$

Symbol	Parameter	BTA 04-			Unit
		200GP	400GP	600GP	
V_{DRM}	Repetitive Peak off-state Voltage (2)	200	400	600	V

(1) $I_G = 750$ mA $dI_G/dt = 1$ A/ μ s(2) $T_J = 110$ °C.**THERMAL RESISTANCES**

Symbol	Parameter	Value	Unit
$R_{th (j-a)}$	Junction to Ambient	60	$^{\circ}\text{C}/\text{W}$
$R_{th (j-c)} \text{ DC}$	Junction to Case for DC	8.7	$^{\circ}\text{C}/\text{W}$
$R_{th (j-c)} \text{ AC}$	Junction to Case for 360° Conduction Angle ($F = 50$ Hz)	6.5	$^{\circ}\text{C}/\text{W}$

GATE CHARACTERISTICS (maximum values)

$P_{GM} = 40 \text{ W}$ ($t_p = 10 \mu\text{s}$) $I_{GM} = 4 \text{ A}$ ($t_p = 10 \mu\text{s}$)
 $P_G(\text{AV}) = 1 \text{ W}$ $V_{GM} = 16 \text{ V}$ ($t_p = 10 \mu\text{s}$)

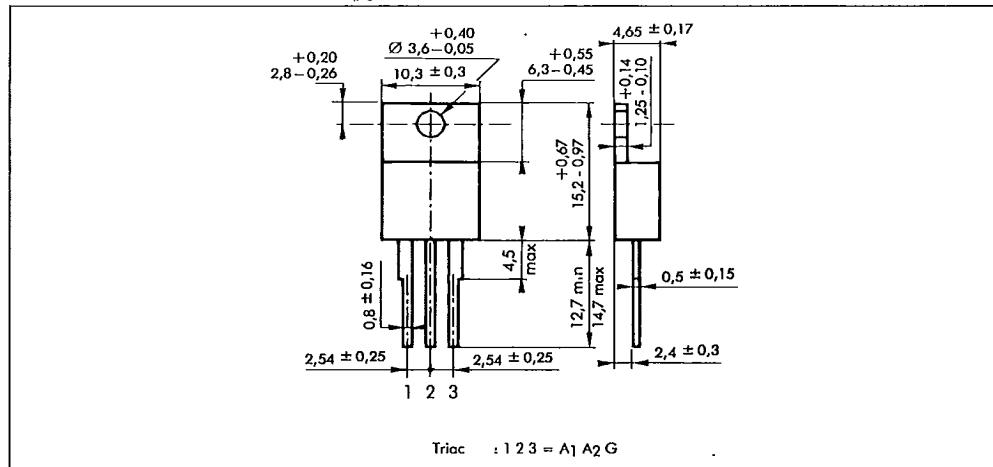
ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions			Quadrants	Min.	Typ.	Max.	Unit
I_{GT}	$T_j = 25^\circ\text{C}$	$V_D = 12 \text{ V}$	$R_L = 33 \Omega$	I-II-III		15	50	mA
	Pulse Duration > 20 μs			IV		25	75	
V_{GT}	$T_j = 25^\circ\text{C}$	$V_D = 12 \text{ V}$	$R_L = 33 \Omega$	I-II-III-IV			1.5	V
V_{GD}	$T_j = 110^\circ\text{C}$	$V_D = V_{DRM}$	$R_L = 3.3 \text{ k}\Omega$	I-II-III-IV	0.2			V
I_H^*	$T_j = 25^\circ\text{C}$	$I_T = 100 \text{ mA}$	Gate Open				13	mA
I_L	$T_j = 25^\circ\text{C}$	$V_D = 12 \text{ V}$	$I_G = 150 \text{ mA}$	I-III-IV		25		mA
	Pulse Duration > 20 μs			II		50		
V_{TM}^*	$T_j = 25^\circ\text{C}$	$I_{TM} = 5.5 \text{ A}$	$t_p = 10 \text{ ms}$				1.65	V
I_{DRM}^*	V_{DRM} Specified		$T_j = 25^\circ\text{C}$				0.01	mA
			$T_j = 110^\circ\text{C}$				0.5	
dv/dt^*	$T_j = 110^\circ\text{C}$ Gate Open Linear Slope up to $V_D = 67\% V_{DRM}$				10			V/ μs
$(dv/dt)_c^*$	$T_C = 75^\circ\text{C}$	$V_D = V_{DRM}$	$I_T = 5.5 \text{ A}$			1		V/ μs
t_{gt}	$T_j = 25^\circ\text{C}$	$V_D = V_{DRM}$	$I_T = 5.5 \text{ A}$	I-II-III-IV		2		μs
	$I_G = 100 \text{ mA}$	$dI_G/dt = 1 \text{ A}/\mu\text{s}$						

* For either polarity of electrode A₂ voltage with reference to electrode A₁.

PACKAGE MECHANICAL DATA

TO 220 AB Plastic



Cooling method : by conduction (method C)

Marking : type number

Weight : 2 g.

S G S-THOMSON

T-25-13

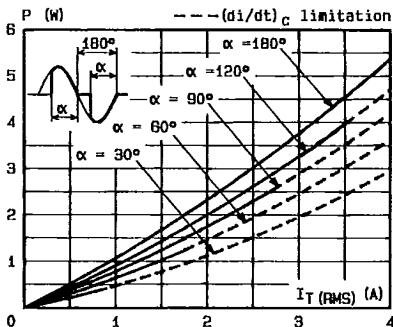


Fig.1 - Maximum mean power dissipation versus RMS on-state current ($F = 60$ Hz).

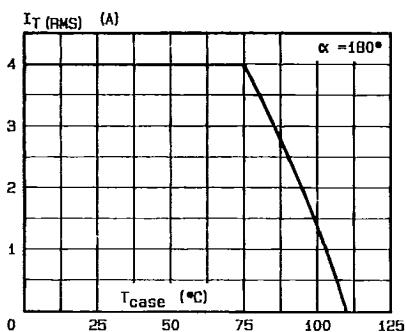


Fig.3 - RMS on-state current versus case temperature.

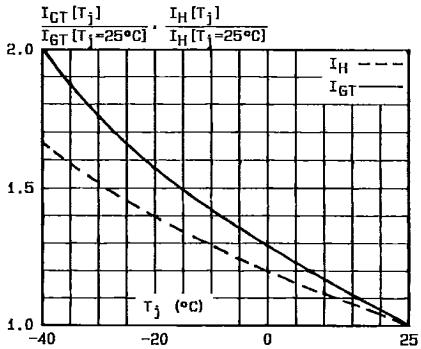


Fig.5 - Relative variation of gate trigger current and holding current versus junction temperature.

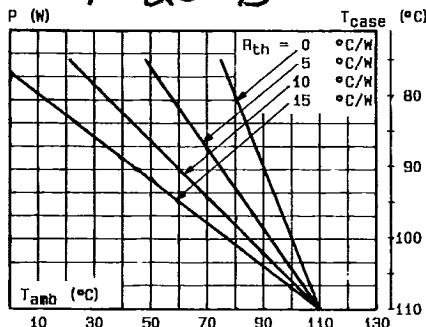


Fig.2 - Correlation between maximum mean power dissipation and maximum allowable temperatures (T_{amb} and T_{case}) for different thermal resistances heatsink + contact.

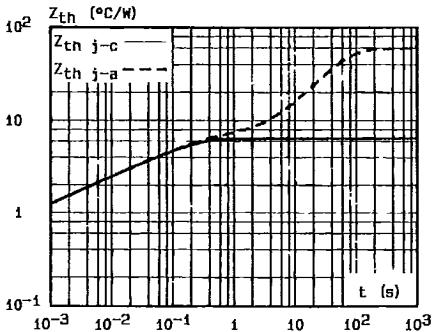


Fig.4 - Thermal transient impedance junction to case and junction to ambient versus pulse duration.

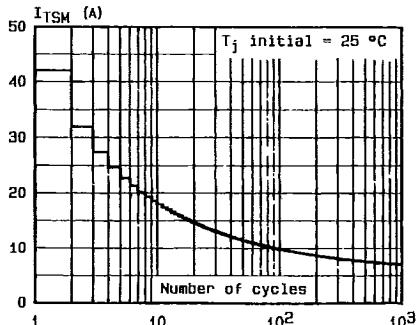


Fig.6 - Non repetitive surge peak on-state current versus number of cycles.

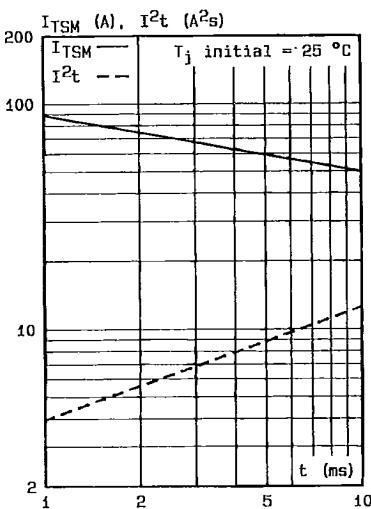


Fig.7 - Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t \leq 10$ ms, and corresponding value of I^2t .

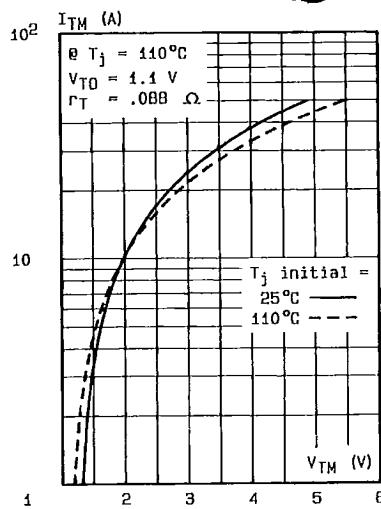


Fig.8 - On-state characteristics (maximum values).